

REAL TIME CLOCK MODULE (I²C-Bus)

Built-in backup battery charge control function





Product Number (2,000 pcs / Reel) **RX8130CE: X1B000311000100**

RX8130CE

Built-in frequency adjusted 32.768 kHz crystal unit
 Interface Type : I²C-Bus
 Low backup current : 300 nA Typ. / 3 V

Auto power switching function : Automatically switches to backup power supply

by monitoring the VDD voltage

Backup battery charge control function : For the rechargeable battery

• Reset functions with a delay : Detect a main power supply and remove the reset

• Interrupt output : Wake up every minute or every second • Alarm interruption : Day, date, hour, minute, second

Auto repeat wakeup timer interruption

• Self-monitoring interruption : Crystal oscillation stop, V_{BAT} low, V_{DD} low



RX8130CE

 $(3.2 \times 2.5 \text{ mm}, t = 1.0 \text{ mm Max.})$

Block diagram

(VDET2) Battery backup connection example (1) Detector (VCMP odic Area 32.768kHz 巾 Registe Control osc Battery backup connection example (2) VBAT Registe Divider secondary and battery User FOUT FOUT Controller

Overview

- Interface type
 I²C-Bus interface Fast-Mode 400 kHz
- Auto power switch function

The \dot{V}_{DD} voltage is monitored and it switches to the backup power supply by the automatic operation Backup power supply switching voltage 1.2V Min.

• Clock output function

Output frequency is selectable from 32.768 kHz, 1024 Hz, 1 Hz

Wakeup timer function

Selectable from 244 µs to 7.5 years (16 bit x 1 ch.) Timer source clock selectable from 1/3600 Hz, 1/60 Hz, 1 Hz, 64 Hz, 4096 Hz. Auto release after interrupt output from /IRQ pin at timer completes

This operation is auto repeat with a selected cycle, it can be used like a watchdog timer

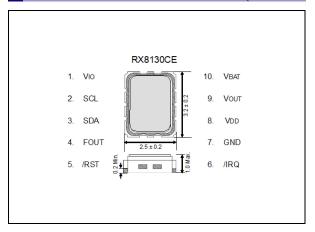
- Backup battery charge control function
 Stop charging automatically by detecting the full charge.
 Records in the register detecting the backup power supply
 Voltage decrease
- Reset function with a delay
 When the main never is aun

When the main power is supplied, reset output is released. The reset/release voltage is selected by the register (2 types) Delay time of release from backup mode is 60ms Min.

Pin Functin

Signal Name	1/0	Function		
SCL	Input	Serial clock input pin		
SDA	Input / Output	Serial data input and output pin		
FOUT	Output	Frequency output pin (CMOS) (frequency selection: 32.768 kHz, 1024 Hz, 1 Hz)		
/RST	Output	Reset output pin (N-ch. open drain) In case of VDD voltage drop detection, a reset signal is outputted In case of VDD voltage rise detection, a released reset signal is outputted		
/IRQ	Output	Interrupts output by Alarm and Timer events (N-ch. open drain)		
VDD	-	Power-supply pin Possible to supply different voltage from Vio		
Vio	_	Interface power supply pin Input to supply the voltage same as a host		
Vout	_	Internal voltage output pin Connect bypass capacitor of 1.0 μF		
VBAT	-	This is a power supply pin for backup battery Connect an EDLC, a secondary battery, a primary battery In the backup voltage range, supplied to IC, from this pin		
GND	_	Ground pin		

Terminal connection / External dimensions (Unit: mm)



Specifications (characteristics)

■ Recommended Operating Conditions Item Symbol Condition Min. Max. Unit Тур. Operating supply voltage VDD 1.25 3.0 5.5 ٧ VCLK 1.1 3.0 5.5 ٧ Clock supply voltage -40 +85 Operating temperature Та +25 ٥С V_{DD} detect voltage -VDET2 VDD, Fall 1.20 1.30 1.40 ٧

■ Frequency characteristics

Item	Symbol	Condition	Rating	Unit
Frequency tolerance	Δf/f	Ta = +25 °C VDD = 3.0 V	B: 5 ± 23	x 10-6
Oscillation start-up time	tsta	V _{DD} = 2.75 V to 5.5 V	1 Max.	s

* Refer to application manual for details

 Current consumption characteristics 					Ta = -40 °C to +85 °C		
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Current consumption	Іват	SCL = SDA = "L", VBAT = 3.0 V, VDD = VIO = 0.0 V	-	300	500	nA	
	I _{32k}	SCL = SDA = "H", FOUT = 32.768 kHz, //RQ=OFF, VDD = VIo = 3.0 V, FOUT pin CL = 15 pF, CHGEN = L or VBAT ≧ VDET3	-	3.5	4.0	μА	

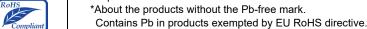
Explanation of the mark that are using it for the catalog



▶Pb free.



▶ Complies with EU RoHS directive.



(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive general equipment.



▶ Designed for automotive applications related to driving and safety.

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